

## 74VHC393 Dual 4-Bit Binary Counter

### General Description

The VHC393 is an advanced high speed CMOS 4-bit Binary Counter fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. It contains two independent counter circuits in one package, so that counting or frequency division of 8 binary bits can be achieved with one IC. This device changes state on the negative going transition of the CLOCK pulse. The counter can be reset to "0" ( $Q_0-Q_3 = "L"$ ) by a HIGH at the CLEAR input regardless of other inputs.

An input protection circuit ensures that 0V to 7V can be applied to the input pins without regard to the supply volt-

age. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

### Features

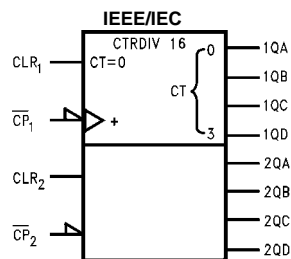
- High Speed:  $f_{MAX} = 170$  MHz (typ) at  $T_A = 25^\circ\text{C}$
- Low power dissipation:  $I_{CC} = 4$   $\mu\text{A}$  (max) at  $T_A = 25^\circ\text{C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (min)
- Power down protection is provided on all inputs
- Pin and function compatible with 74HC393

### Ordering Code:

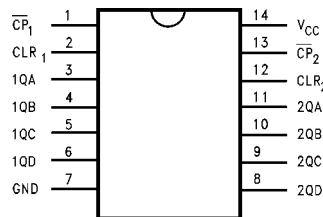
Order Number	Package Number	Package Description
74VHC393M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
74VHC393SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC393MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC393N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### Logic Symbol





### Connection Diagram



### Pin Descriptions

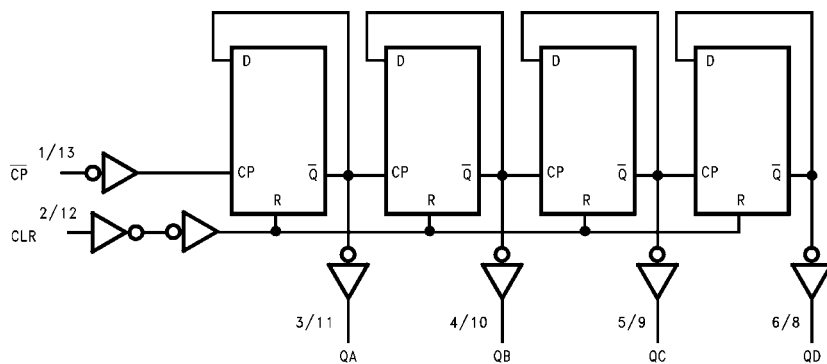
Pin Names	Description
CLR1, CLR2	Clear Inputs
$\overline{CP}_1, \overline{CP}_2$	Clock Pulse Inputs
QA, QB, QC, QD	Outputs

**Truth Table**

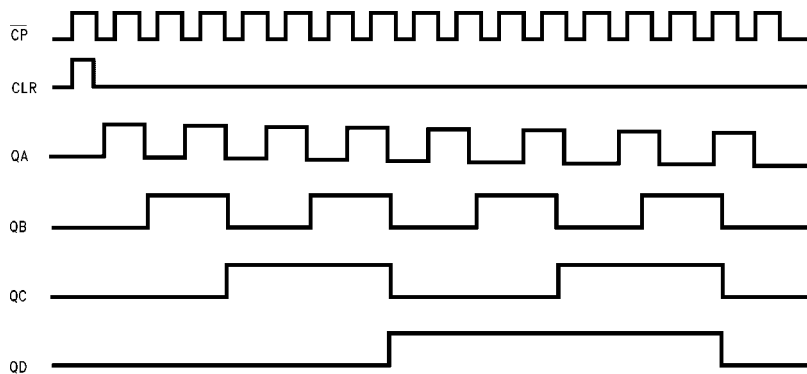
Inputs		Outputs			
$\overline{CP}$	CLR	QA	QB	QC	QD
X	H	L	L	L	L
	L	Count Up			
	L	No Change			

X: Don't Care

**System Diagram**



**Timing Chart**



**Absolute Maximum Ratings** (Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Input Voltage ( $V_{IN}$ )	-0.5V to +7.0V
DC Output Voltage ( $V_{OUT}$ )	-0.5V to $V_{CC} + 0.5V$
Input Diode Current ( $I_{IK}$ )	-20 mA
Output Diode Current ( $I_{OK}$ )	$\pm 20$ mA
DC Output Current ( $I_{OUT}$ )	$\pm 25$ mA
DC $V_{CC}/GND$ Current ( $I_{CC}$ )	$\pm 75$ mA
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C
Lead Temperature ( $T_L$ ) (Soldering, 10 seconds)	260°C

**Recommended Operating Conditions** (Note 2)

Supply Voltage ( $V_{CC}$ )	2.0V to +5.5V
Input Voltage ( $V_{IN}$ )	0V to +5.5V
Output Voltage ( $V_{OUT}$ )	0V to $V_{CC}$
Operating Temperature ( $T_{OPR}$ )	-40°C to +85°C
Input Rise and Fall Time ( $t_r, t_f$ )	
$V_{CC} = 3.3V \pm 0.3V$	0 ~ 100 ns/V
$V_{CC} = 5.0V \pm 0.5V$	0 ~ 20 ns/V

**Note 1:** Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifications.

**Note 2:** Unused inputs must be held HIGH or LOW. They may not float.

**DC Electrical Characteristics**

Symbol	Parameter	$V_{CC}$ (V)	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Units	Conditions		
			Min	Typ	Max	Min	Max				
$V_{IH}$	HIGH Level	2.0	1.50			1.50		V			
	Input Voltage	3.0 – 5.5	$0.7 V_{CC}$			$0.7 V_{CC}$					
$V_{IL}$	LOW Level	2.0	0.50			0.50		V			
	Input Voltage	3.0 – 5.5	$0.3 V_{CC}$			$0.3 V_{CC}$					
$V_{OH}$	HIGH Level	2.0	1.9	2.0	1.9		V	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -50 \mu\text{A}$		
		3.0	2.9	3.0	2.9						
	Output Voltage	4.5	4.4	4.5	4.4		V		$I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$		
		3.0	2.58		2.48						
$V_{OL}$	LOW Level	2.0	0.0			0.1		V	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 50 \mu\text{A}$	
		3.0	0.0			0.1					
	Output Voltage	4.5	0.0			0.1		V		$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$	
		3.0				0.36					
		4.5				0.36					
$I_{IN}$	Input Leakage Current	0 – 5.5				$\pm 0.1$		$\mu\text{A}$	$V_{IN} = 5.5V$ or GND		
$I_{CC}$	Quiescent Supply Current	5.5				4.0		$\mu\text{A}$	$V_{IN} = V_{CC}$ or GND		

## AC Electrical Characteristics

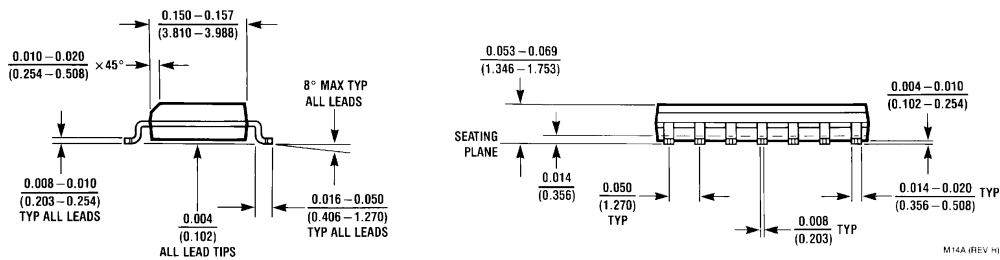
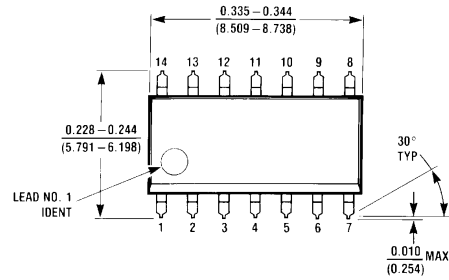
Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C		Units	Conditions
			Min	Typ	Max	Min	Max		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CP-QA)	3.3 ± 0.3	8.6	13.2	1.0	15.5	ns	C <sub>L</sub> = 15 pF	
		5.0 ± 0.5	11.1	16.7	1.0	19.0		C <sub>L</sub> = 50 pF	
			5.8	8.5	1.0	10.0	ns	C <sub>L</sub> = 15 pF	
			7.3	10.5	1.0	12.0		C <sub>L</sub> = 50 pF	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CP-QB)	3.3 ± 0.3	10.2	15.8	1.0	18.5	ns	C <sub>L</sub> = 15 pF	
		5.0 ± 0.5	12.7	19.3	1.0	22.0		C <sub>L</sub> = 50 pF	
			6.8	9.8	1.0	11.5	ns	C <sub>L</sub> = 15 pF	
			8.3	11.8	1.0	13.5		C <sub>L</sub> = 50 pF	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CP-QC)	3.3 ± 0.3	11.7	18.0	1.0	21.0	ns	C <sub>L</sub> = 15 pF	
		5.0 ± 0.5	14.2	21.5	1.0	24.5		C <sub>L</sub> = 50 pF	
			7.7	11.2	1.0	13.0	ns	C <sub>L</sub> = 15 pF	
			9.2	13.2	1.0	15.0		C <sub>L</sub> = 50 pF	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CP-QD)	3.3 ± 0.3	13.0	19.7	1.0	23.0	ns	C <sub>L</sub> = 15 pF	
		5.0 ± 0.5	15.5	23.2	1.0	26.5		C <sub>L</sub> = 50 pF	
			8.5	12.5	1.0	14.5	ns	C <sub>L</sub> = 15 pF	
			10.0	14.5	1.0	16.5		C <sub>L</sub> = 50 pF	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time (CLR-Q <sub>n</sub> )	3.3 ± 0.3	7.9	12.3	1.0	14.5	ns	C <sub>L</sub> = 15 pF	
		5.0 ± 0.5	10.4	15.8	1.0	18.0		C <sub>L</sub> = 50 pF	
			5.4	8.1	1.0	9.5	ns	C <sub>L</sub> = 15 pF	
			6.9	10.1	1.0	11.5		C <sub>L</sub> = 50 pF	
f <sub>MAX</sub>	Maximum Clock	3.3 ± 0.3	75	120	65		MHz	C <sub>L</sub> = 15 pF	
			45	65	35			C <sub>L</sub> = 50 pF	
		5.0 ± 0.5	125	170	105			C <sub>L</sub> = 15 pF	
			85	115	75			C <sub>L</sub> = 50 pF	
C <sub>IN</sub>	Input Capacitance		4	10	10		pF	V <sub>CC</sub> = Open	
C <sub>PD</sub>	Power Dissipation Capacitance		23				pF	(Note 3)	

**Note 3:** C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load Average operating current can be obtained by the equation: I<sub>CC(opr.)</sub> = C<sub>PD</sub> \* V<sub>CC</sub> \* f<sub>IN</sub> + I<sub>CC/2</sub> (per Counter)

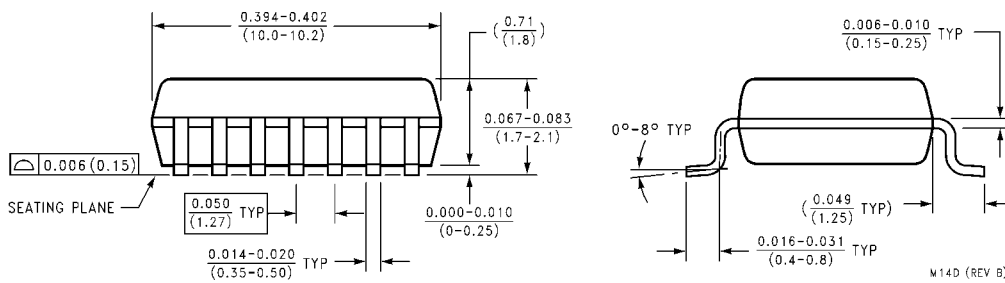
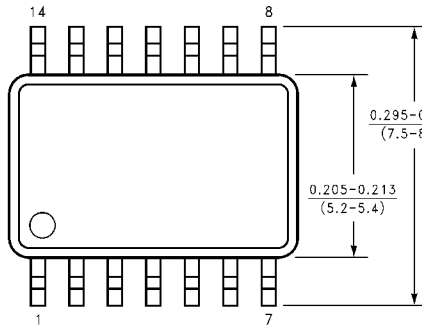
## AC Operating Requirements

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C		T <sub>A</sub> = -40°C to +85°C		Units
			Typ	Guaranteed Minimum			
t <sub>W(L)</sub> t <sub>W(H)</sub>	Minimum Pulse Width (CP)	3.3 ± 0.3 5.0 ± 0.5		5.0	5.0		ns
				5.0	5.0		
t <sub>W(H)</sub>	Minimum Pulse Width (CLR)	3.3 ± 0.3 5.0 ± 0.5		5.0	5.0		ns
				5.0	5.0		
t <sub>REM</sub>	Minimum Removal Time	3.3 ± 0.3 5.0 ± 0.5		5.0	5.0		ns
				4.0	4.0		

**Physical Dimensions** inches (millimeters) unless otherwise noted



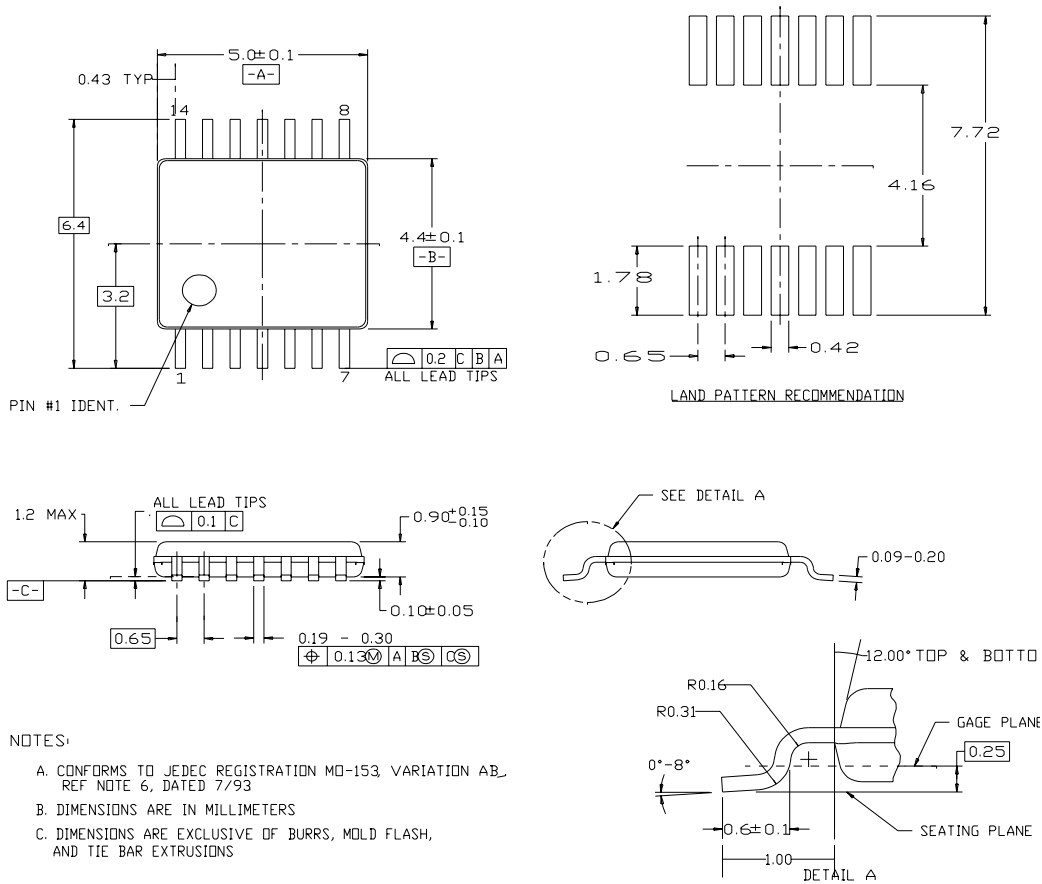
**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow  
Package Number M14A**



**14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide  
Package Number M14D**

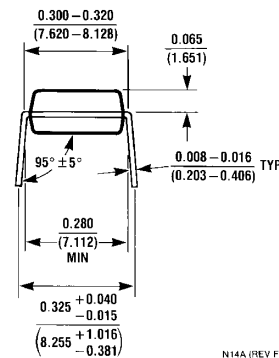
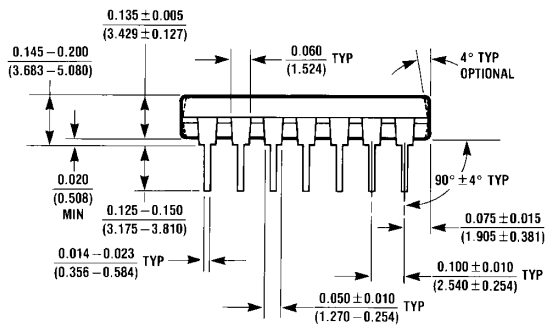
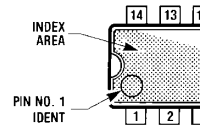
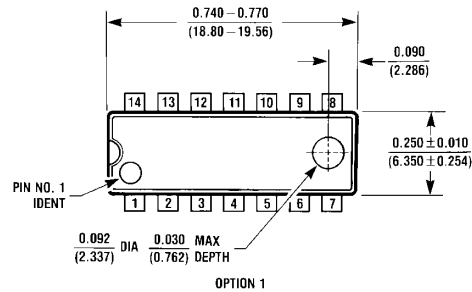
**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE



**14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide  
Package Number MTC14**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



N14A (REV F)

**14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N14A**

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